



ENVIRONMENTAL AND PACKAGE TESTING DATA FOR SC-70-6L (Cu)					
STRESS	SAMPLE SIZE	DEVICE HR./CYC	CONDITION	TOTAL FAILS	FAIL PERCENTAGE
HAST	150	15 000	130 °C, 85 % RH	0	0
Pressure Pot	400	38 400	121°, 15 PSIG	0	0
Solder Dunk	130	390	260 °C, 10 s	0	0
Temp. Cycle	1200	390 000	-55 °C to 150 °C	0	0